





40V PNP HIGH GAIN LOW SATURATION MEDIUM POWER TRANSISTOR IN SOT89

Description

This bipolar junction transistor (BJT) is designed to meet the stringent requirements of automotive applications.

Features

- BV_{CEO} > -40V
- I_C = -5.5A High Continuous Current
- I_{CM} = -15A Peak Pulse Current
- $R_{CE(sat)} = 29m\Omega$ for a low equivalent On-Resistance
- Low Saturation Voltage V_{CE(sat)} < -60mV @ -1A
- h_{FE} Specified Up to -10A for High Current Gain Hold Up
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DIODES™ ZX5T3ZQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

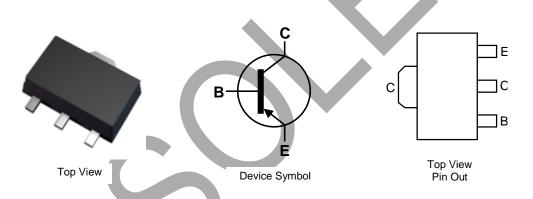
https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOT89
- Package Material: Molded Plastic. "Green" Molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.05 grams (Approximate)

Applications

- Charging circuits
- DC-DC converters
- MOSFET and IGBT gate driving
- Power switches
- Motor control



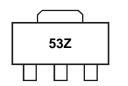
Ordering Information (Note 4)

Part Number	Pankaga	Marking Reel Size (inches)		Tape Width (mm)	Packing	
Fait Number	Package	Warking	Reel Size (Iliches)	rape widin (iliin)	Qty.	Carrier
ZX5T3ZQTA	SOT89	53Z	7	12	1,000	Reel
ZX5T3ZQTC	SOT89	53Z	13	12	4,000	Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



53Z = Product Type Marking Code

ZX5T3ZQ
Datasheet number: DS45274 Rev. 1 - 4



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Limit	Unit
Collector-Base Voltage	V_{CBO}	-50	V
Collector-Base Voltage	V _{CBS}	-50	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V_{EBO}	-7.5	٧
Continuous Collector Current	I _C	-5.5	Α
Peak Pulse Current	I _{CM}	-15	А

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Note 5)		0.9		
Power Dissipation	(Note 6)	D.	1.5	w	
Power Dissipation	(Note 7)	P _D	2.1	VV	
	(Note 8)		3.0		
	(Note 5)		139	°C/W	
Thermal Decistance, Junction to Ambient Air	(Note 6)	D	83	C/VV	
Thermal Resistance, Junction to Ambient Air	(Note 7)	R _{0JA}	60		
	(Note 8)		42		
Thermal Resistance, Junction to Lead	(Note 9)	$R_{ heta JL}$	2.81	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

ESD Ratings (Note 10)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

- 5. For a device mounted with the exposed collector pad on 15mm x 15mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

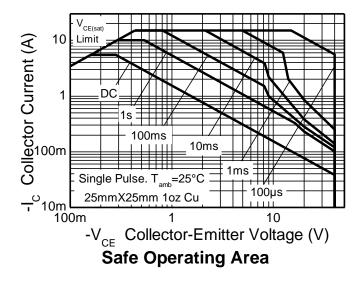
 6. Same as note (5), except the device is mounted on 25mm x 25mm 1oz copper.

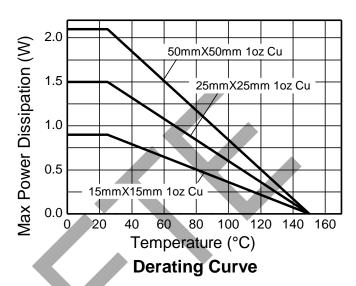
- 7. Same as note (5), except the device is mounted on 50mm x 50mm 1oz copper.

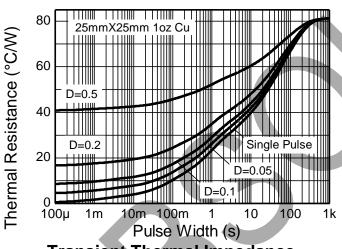
 8. Same as note (5), except the device is mounted on 25mm x 25mm 1oz copper and measured at t<5secs.
- Thermal resistance from junction to solder-point (on the exposed collector pad).
 Refer to JEDEC specification JESD22-A114 and JESD22-A115.

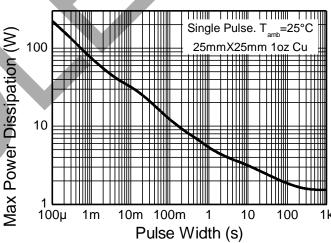


Thermal Characteristics and Derating Information









Transient Thermal Impedance

Pulse Power Dissipation



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

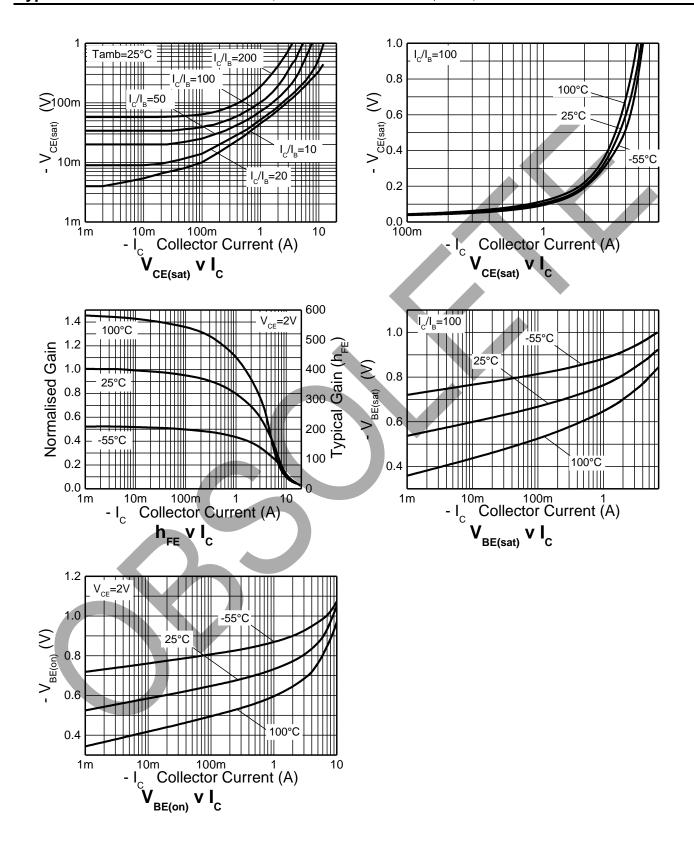
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-50	-90	_	V	I _C = -100μA
Collector-Emitter Breakdown Voltage	BV _{CES}	-50	-90	_	V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 11)	BV _{CEO}	-40	-58	_	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7.5	-8.3	_	V	I _E = -100μA
Collector Cutoff Current	I _{CBO}	_	1	-20	nA	V _{CB} = -40V
Collector Cutoff Current	I _{CES}	_	1	-20	nA	V _{CE} = -32V
Emitter Cutoff Current	I _{EBO}	_	1	-20	nA	V _{EB} = -6V
DC Current Transfer Static Ratio (Note 11)	h _{FE}	200 200 170 110	390 350 290 175	- 550 - -		I _C = -10mA, V _{CE} = -2V I _C = -0.5A, V _{CE} = -2V I _C = -2A, V _{CE} = -2V I _C = -5.5A, V _{CE} = -2V
Collector-Emitter Saturation Voltage (Note 11)	VCE(sat)		-15 -44 -50 -120 -70 -125 -130 -162	-30 -60 -70 -165 -80 -175 -175 -185	mV	$I_C = -0.1A$, $I_B = -10mA$ $I_C = -1A$, $I_B = -100mA$ $I_C = -1A$, $I_B = -50mA$ $I_C = -1A$, $I_B = -10mA$ $I_C = -2A$, $I_B = -200mA$ $I_C = -2A$, $I_B = -40mA$ $I_C = -3.5A$, $I_B = -175mA$ $I_C = -5.5A$, $I_B = -550mA$
Base-Emitter Saturation Voltage (Note 11)	V _{BE(sat)}		-820 -1000	-900 -1075	mV	$I_C = -3.5A$, $I_B = -350 \text{mA}$ $I_C = -2A$, $I_B = -40 \text{mA}$ $I_C = -5.5A$, $I_B = -550 \text{mA}$
Base-Emitter Turn-On Voltage (Note 11)	V _{BE(om)}	-	-778 -869	-850 -950	mV	I _C = -2A, V _{CE} = -2V I _C = -5.5A, V _{CE} = -2V
Transitional Frequency	f _T	1	152	_	MHz	$I_C = -50 \text{mA}, V_{CE} = -10 \text{V}$ f = 100MHz
Output Capacitance	C_{obo}	_	53	_	pF	$V_{CB} = -10V$, $f = 1MHz$,
Switching Times	t _d t _r t _s		18 17 325 60	_	nS	$I_C = -1A$, $V_{CC} = -10V$ $I_{B1} = -I_{B2} = -100mA$
Switching Times	t _d t _r t _s t _f	_	55 107 264 103	_	nS	$I_C = -2A$, $V_{CC} = -30V$ $I_{B1} = -I_{B2} = -20mA$

Note:

11. Measured under pulsed conditions. Pulse width ≤ 300µs. Duty cycle ≤ 2%.



Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

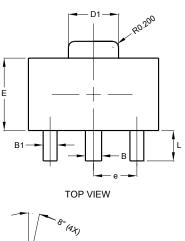


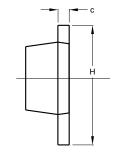


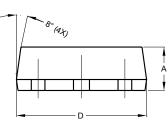
Package Outline Dimensions

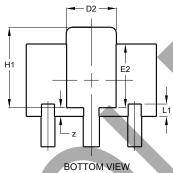
Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT89







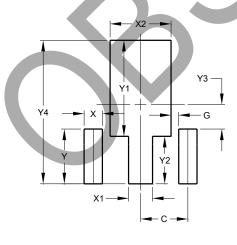


SOT89					
Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
В	0.50	0.62	0.56		
B1	0.42	0.54	0.48		
С	0.35	0.43	0.38		
D	4.40	4.60	4.50		
D1	1.62	1.83	1.733		
D2	1.61	1.81	1.71		
Е	2.40	2.60	2.50		
E2	2.05	2.35	2.20		
е	-	1	1.50		
Η	3.95	4.25	4.10		
H1	2.63	2.93	2.78		
L	0.90	1.20	1.05		
L1	0.327	0.527	0.427		
Z	0.20	0.40	0.30		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT89



Dimensions	Value (in mm)
С	1.500
G	0.244
Х	0.580
X1	0.760
X2	1.933
Υ	1.730
Y1	3.030
Y2	1.500
Y3	0.770
Y4	4.530



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